



MMSTA13/MMSTA14

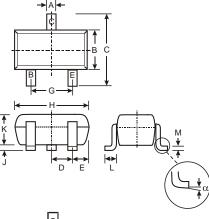
NPN SURFACE MOUNT DARLINGTON TRANSISTOR

Features

- Epitaxial Planar Die Construction
- Complementary PNP Type Available (MMSTA63/MMSTA64)
- Ideal for Low Power Amplification and Switching
- High Current Gain
- Ultra-Small Surface Mount Package
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device (Note 3 and 4)

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- MMSTA13 Marking K2D, K3D (See Page 3)
- MMSTA14 Marking K3D (See Page 3)
- Ordering & Date Code Information: See Page 3
- Weight: 0.006 grams (approximate)



SOT-323										
Dim	Dim Min Max									
Α	0.25	0.40								
В	1.15	1.35								
С	2.00	2.20								
D	0.65 N	ominal								
E	0.30 0.40									
G	1.20	1.40								
Н	1.80 2.20									
J	0.0	0.10								
K	0.90	1.00								
L	0.25	0.40								
М	0.10	0.18								
	0°	8°								
All Din	nensions	in mm								



Maximum Ratings @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	30	V
Collector-Emitter Voltage	V _{CEO}	30	V
Emitter-Base Voltage	V _{EBO}	10	V
Collector Current - Continuous (Note 1)	Ic	300	mA
Power Dissipation (Note 1)	Pd	200	mW
Thermal Resistance, Junction to Ambient (Note 1)	R _{JA}	625	°C/W
Operating and Storage and Temperature Range	T _j , T _{STG}	-55 to +150	°C

Note: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

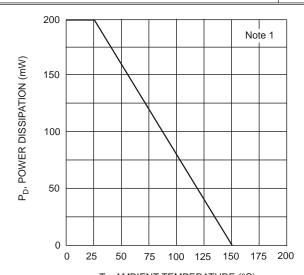
- 2. No purposefully added lead.
- 3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 4. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

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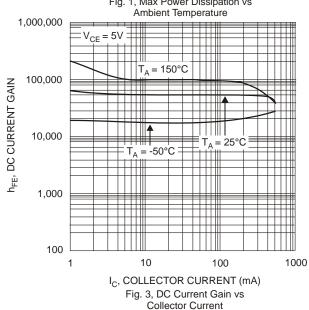
Electrical Characteristics @ TA = 25°C unless otherwise specified

间"MMSTA13-7-Ch"描磁磁商ic	Symbol	Min	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 5)	•	•	•			
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	30		V	I _C = 100μA V _{BE} = 0V	
Collector Cutoff Current	I _{CBO}		100	nA	$V_{CB} = 30V, I_{E} = 0$	
Emitter Cutoff Current	I _{EBO}		100	nA	V _{EB} = 10V, I _C = 0	
ON CHARACTERISTICS (Note 5)						
DC Current Gain MMSTA1 MMSTA1 MMSTA1 MMSTA1 MMSTA1	h _{FE}	5,000 10,000 10,000 20,000			IC = 10mA, VCE = 5.0V IC = 10mA, VCE = 5.0V IC = 100mA, VCE = 5.0V IC = 100mA, VCE = 5.0V	
Collector-Emitter Saturation Voltage	V _{CE} (SAT)		1.5	V	$I_C = 100 \text{mA}, I_B = 100 \mu\text{A}$	
Base-Emitter Saturation Voltage	V _{BE(SAT)}		2.0	V	I _C = 100mA, V _{CE} = 5.0V	
SMALL SIGNAL CHARACTERISTICS	•	•	•	•		
Output Capacitance	C _{obo}	8.0 Typical		pF	V _{CB} = 10V, f = 1.0MHz, I _E = 0	
Input Capacitance	C _{ibo}	15 Ty	ypical	pF	$V_{EB} = 0.5V$, $f = 1.0MHz$, $I_{C} = 0$	
Current Gain-Bandwidth Product		125		MHz	V _{CE} = 5.0V, I _C = 10mA, f = 100MHz	

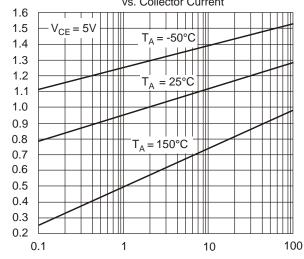


1.10 V_{CE(SAT)}, COLLECTOR TO EMITTER SATURATION VOLTAGE (V) 1.05 1.00 $T_A = -50$ °C 0.95 0.90 0.85 0.80 = 25°C 0.75 0.70 0.65 0.60 $T_A = 150^{\circ}C$ 0.55 0.50 0.45 0.40 10 100 1000





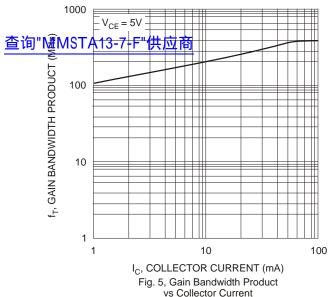




I_C, COLLECTOR CURRENT (mA) Fig. 4, Base Emitter Voltage vs. Collector Current

 $V_{\text{BE}(ON)}$, BASE EMITTER VOLTAGE (V)





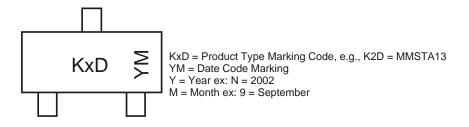
Ordering Information (Note 4 & 6)

Device	Packaging	Shipping		
MMSTA13-7-F MMSTA14-7-F	SOT-323	3000/Tape & Reel		

Notes: 4. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

- 5. Short duration pulse test used to minimize self-heating effect.
- 6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



Date Code Key

Year	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	L	М	N	Р	R	S	Т	U	V	W	X	Υ	Z

Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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